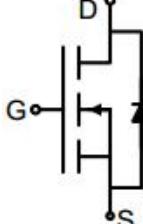
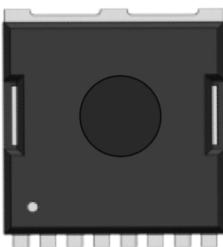


N-Channel Enhancement Mode Power MOSFET

<p>Description</p> <p>The GT020N10TL uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.</p> <p>General Features</p> <ul style="list-style-type: none"> ● V_{DS} 100V ● I_D (at $V_{GS} = 10V$) 300A ● $R_{DS(ON)}$ (at $V_{GS} = 10V$) < 1.9mΩ ● 100% Avalanche Tested ● RoHS Compliant <p>Application</p> <ul style="list-style-type: none"> ● Power switch ● DC/DC converters 	 <p>Schematic diagram</p>  <p>TOLL-8L</p> <p>G₁ S₂ S₃ S₄ S₅ S₆ S₇ S₈</p>
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Ordering Information

Device	Package	Marking	Packaging
GT020N10TL	TOLL-8L	GT020N10	2000pcs/Reel

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	100	V
Continuous Drain Current $T_C = 25^\circ\text{C}$	I_D	300	A
$T_C = 100^\circ\text{C}$		190	
Pulsed Drain Current (note1)	I_{DM}	1200	A
Gate-Source Voltage	V_{GS}	± 20	V
Power Dissipation	P_D	330	W
Single pulse avalanche energy (note2)	E_{AS}	812	mJ
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	°C

Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	40	°C/W
Maximum Junction-to-Case	R_{thJC}	0.38	°C/W

Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	100	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 100\text{V}, V_{\text{GS}} = 0\text{V}$	--	--	1	μA
Gate-Source Leakage	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}$	--	--	± 100	nA
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	2.3	2.8	3.7	V
Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 100\text{A}$	--	1.65	1.9	$\text{m}\Omega$
Forward Transconductance	g_{FS}	$V_{\text{GS}} = 5\text{V}, I_D = 100\text{A}$	--	94	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 50\text{V}, f = 0.8\text{MHz}$	--	10600	--	pF
Output Capacitance	C_{oss}		--	1370	--	
Reverse Transfer Capacitance	C_{rss}		--	370	--	
Total Gate Charge	Q_g	$V_{\text{DD}} = 50\text{V}, I_D = 100\text{A}, V_{\text{GS}} = 10\text{V}$	--	160	--	nC
Gate-Source Charge	Q_{gs}		--	53	--	
Gate-Drain Charge	Q_{gd}		--	60	--	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 50\text{V}, I_D = 100\text{A}, R_G = 6\Omega$	--	57	--	ns
Turn-on Rise Time	t_r		--	124	--	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	116	--	
Turn-off Fall Time	t_f		--	47	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	$T_C = 25^\circ\text{C}$	--	--	300	A
Body Diode Voltage	V_{SD}	$T_J = 25^\circ\text{C}, I_{\text{SD}} = 100\text{A}, V_{\text{GS}} = 0\text{V}$	--	--	1.2	V
Reverse Recovery Charge	Q_{rr}	$I_F = 100\text{A}, V_{\text{GS}} = 0\text{V}$ $dI/dt = 100\text{A}/\mu\text{s}$	--	139	--	nC
Reverse Recovery Time	T_{rr}		--	64	--	ns

Notes

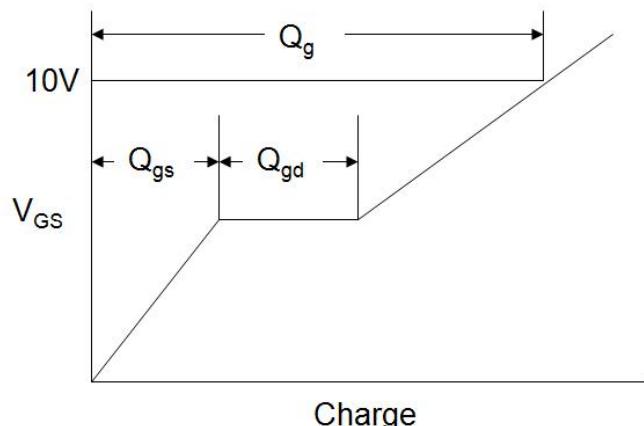
1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. EAS condition : $T_J=25^\circ\text{C}$, $V_{\text{DD}}=50\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.5\text{mH}$, $R_G=25\Omega$

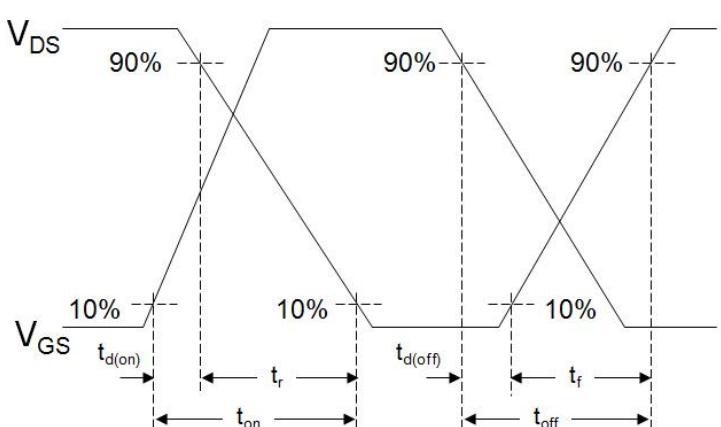
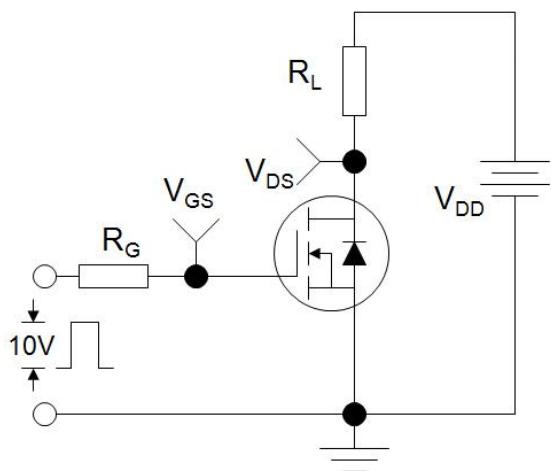
The table shows the minimum avalanche energy, which is 2256mJ when the device is tested until failure

3. Identical low side and high side switch with identical R_G

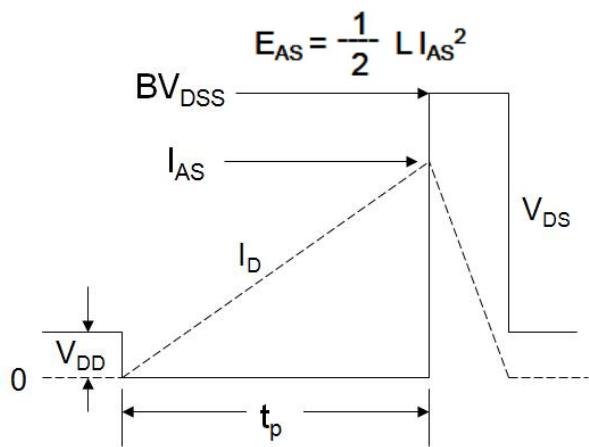
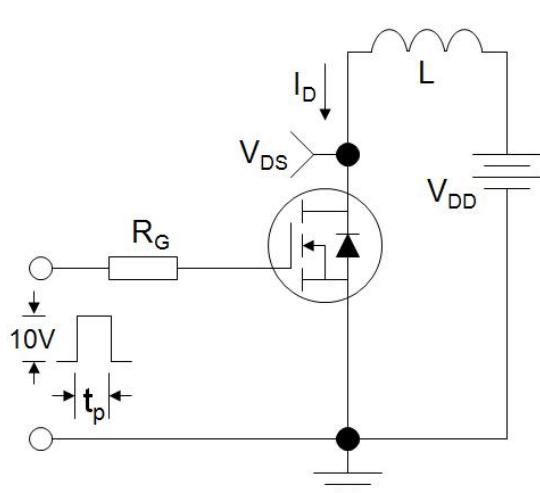
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

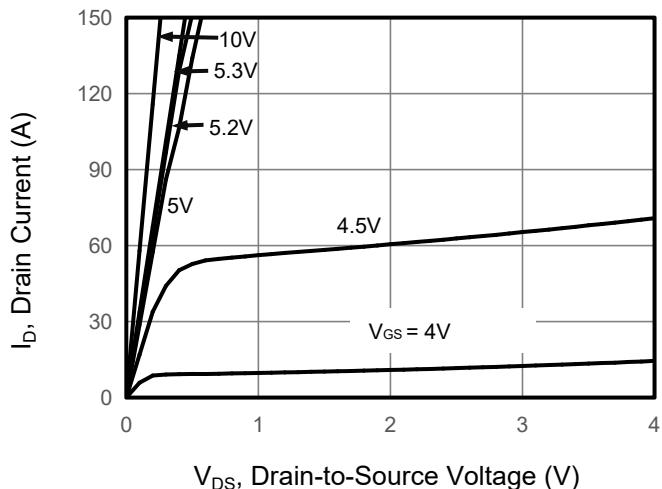


Figure 2. Transfer Characteristics

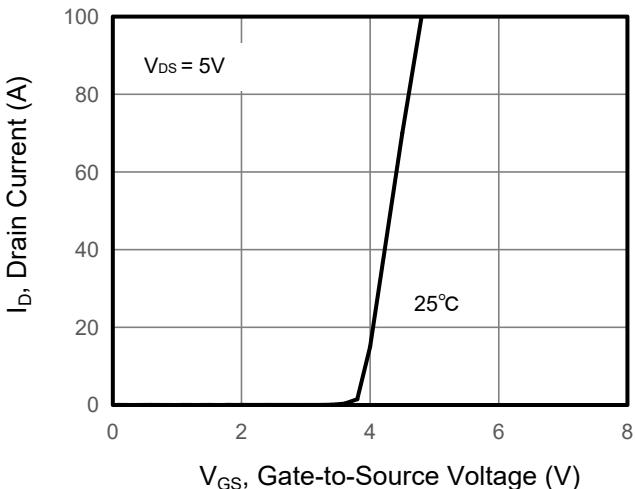


Figure 3. Drain Source On Resistance

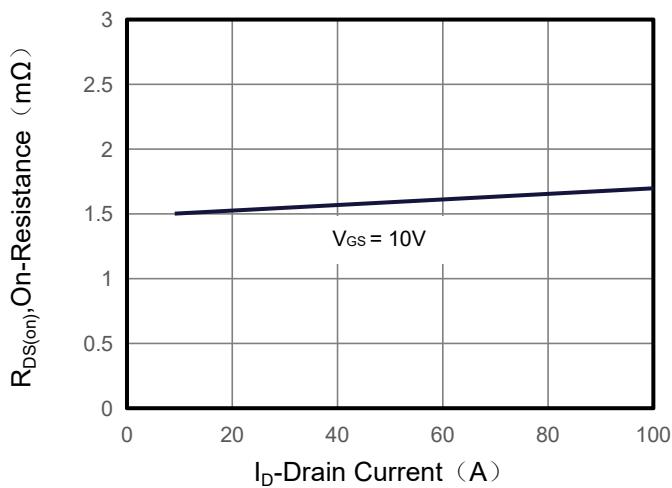


Figure 4. Gate Charge

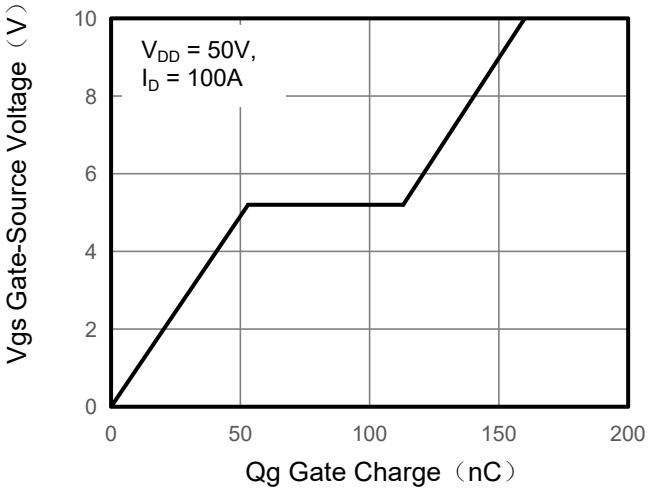


Figure 5. Capacitance

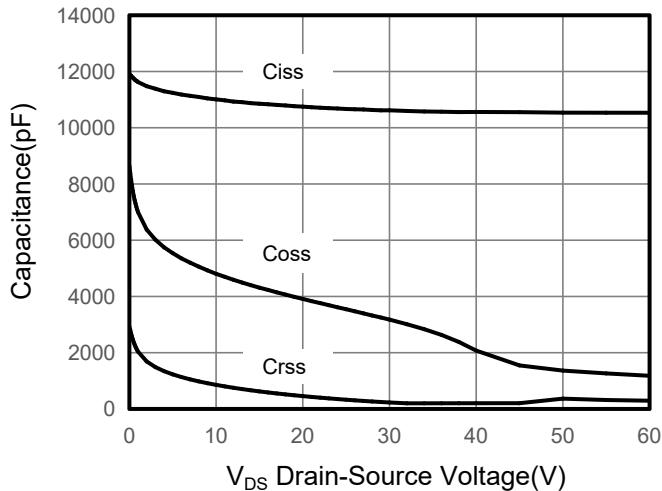
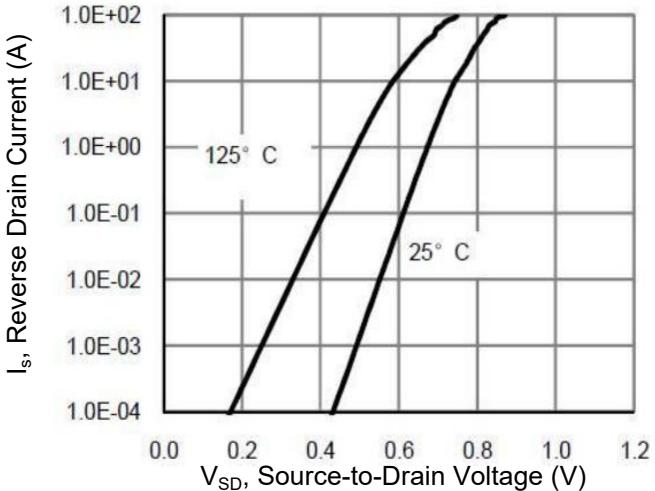


Figure 6. Source-Drain Diode Forward



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

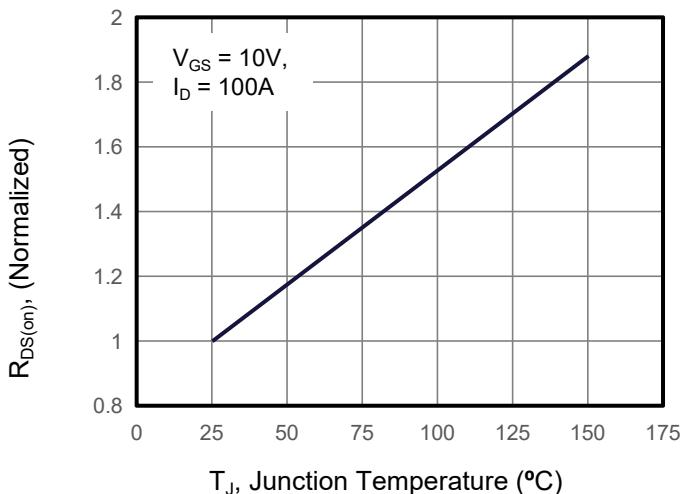


Figure 8. Safe Operation Area

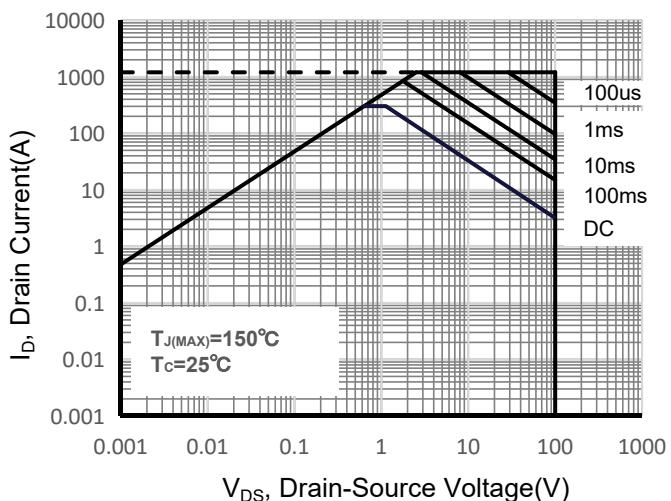


Figure 9. Maximum Continuous Drain Current vs Case Temperature

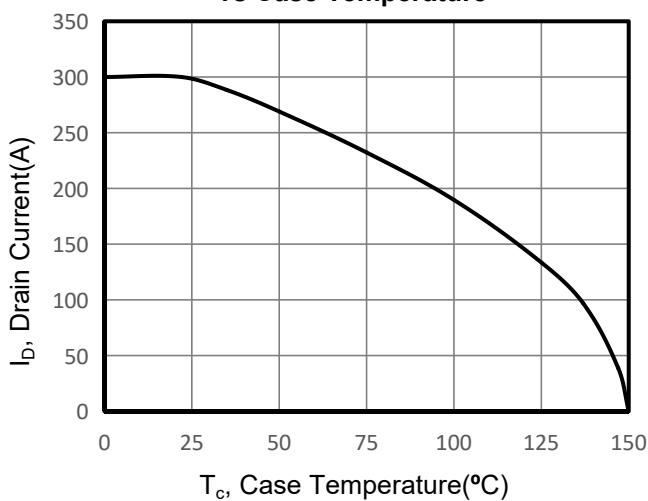
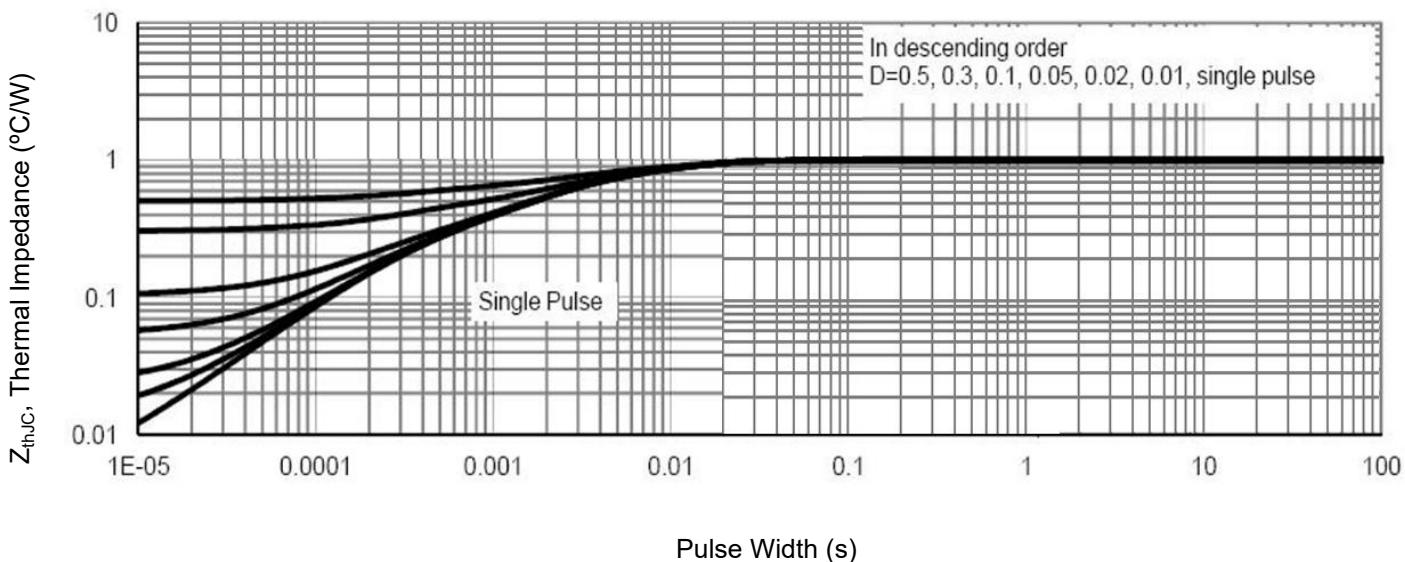
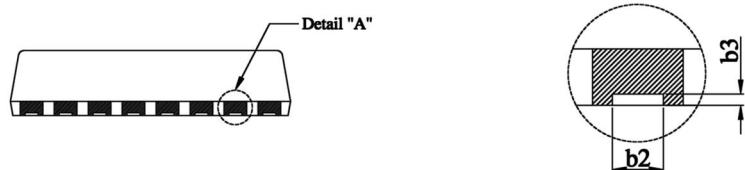
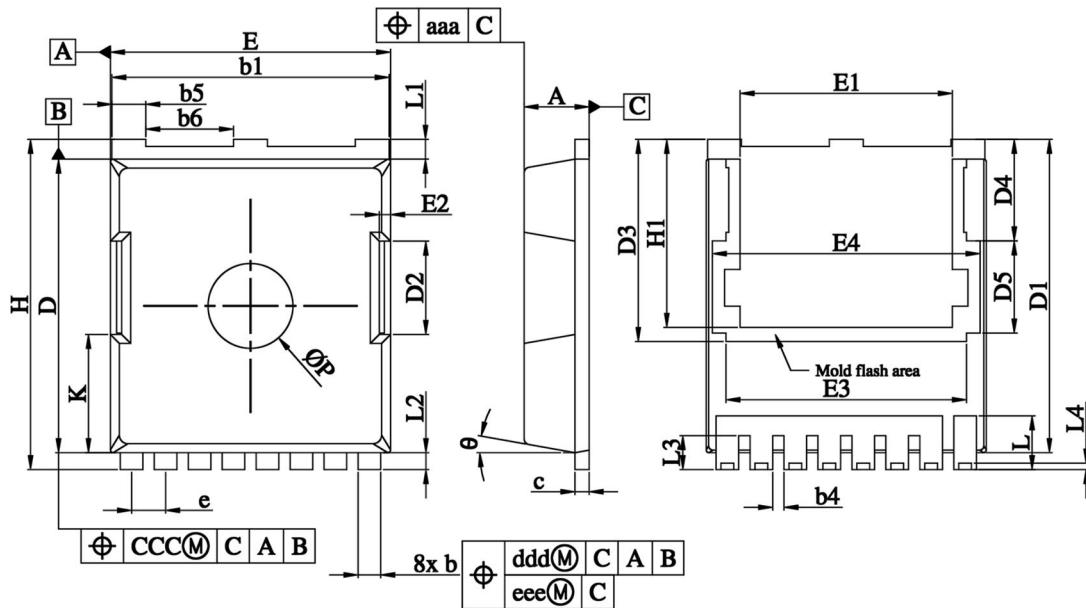


Figure 10. Normalized Maximum Transient Thermal Impedance



TOLL-8L Package Information



SYMBOL	COMMON			SYMBOL	COMMON			
	MILLIMETER				MILLIMETER			
	MIN.	NOMINAL	MAX.		MIN.	NOMINAL	MAX.	
A	2.20	2.30	2.40	E2	0.30	0.40	0.50	
b	0.70	0.80	0.90	E3		8.50		
b1	9.70	9.80	9.90	E4		9.46		
b2	0.36	0.45	0.55	H	11.50	11.68	11.85	
b3	0.05	0.100	/	H1	6.55	6.65	6.75	
b4	0.30	0.40	0.50	K	4.08	4.18	4.28	
b5	1.10	1.20	1.30	L	1.60	1.90	2.10	
b6	3.00	3.10	3.20	L1	0.50	0.70	0.90	
c	0.40	0.50	0.60	L2	0.50	0.60	0.70	
D	10.28	10.38	10.55	L3	1.00	1.20	1.30	
D1	10.98	11.08	11.18	L4	0.13	0.23	0.33	
D2	3.20	3.30	3.40	P	2.85	3.00	3.15	
D3	7.15			θ	10° REF			
D4	3.59			aaa	0.20			
D5	3.26			ccc	0.20			
e	1.10	1.20	1.30	ddd	0.25			
E	9.80	9.90	10.00	eee	0.20			
E1	7.40	7.50	7.60					